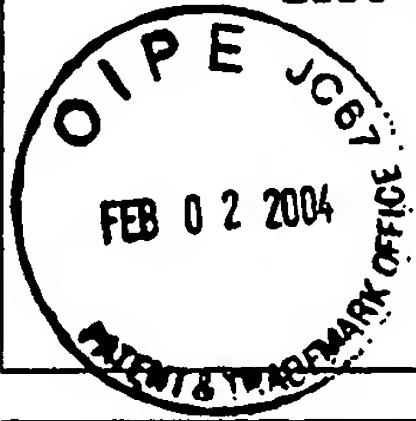


FORM PTO-1449

Atty. Docket No.:  
R22.12-0032Appl. No.:  
10/624,300

LIST OF PATENTS AND PUBLICATIONS FOR  
APPLICANT'S INFORMATION  
DISCLOSURE STATEMENT



First Named Inventor:

Stephen T. Staphanos et al.

Filing Date

Group Art:

July 22, 2003

## U.S. PATENT DOCUMENTS

Examiner Initial	Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
RTF	AA	6,362,540	03/26/02	Hill	307	52
	AB					
	AC					
	AD					
	AE					
	AF					
	AG					
	AH					
	AI					
	AJ					
	AK					
	AL					
	AM					
	AN					

## FOREIGN PATENT DOCUMENTS

	Document No.	Date	Country	Class	Sub Class	Translation Yes No
	AO					
	AP					
	AQ					
	AR					
	AS					
	AT					
	AU					

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

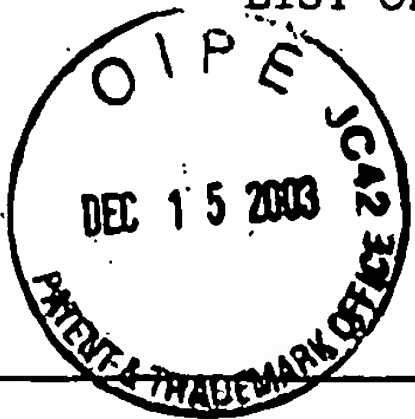
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RTF	AA	4,330,084	05/18/82	Buchner et al.	237	12.1
	AB	4,413,670	11/08/83	Ritter	165	1
	AC	4,494,380	01/22/85	Cross	62	3
	AD	4,738,147	04/19/88	Tomlin	3	864.81
	AE	5,205,177	04/27/93	DuBrock, Jr. et al.	73	863.12
	AF	5,497,630	03/12/96	Stein et al.	62	112
	AG	5,539,638	07/23/96	Keeler et al.	364	424.03
	AH	5,661,463	08/26/97	Letchak et al.	340	636
	AI	5,778,675	07/14/98	Nakhamkin	60	652
	AJ	5,970,426	10/19/99	Mandel et al.	702	32
	AK	6,148,659	11/21/00	Traina	73	25.01
	AL	6,173,567	01/16/01	Poola et al.	60	724
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RTF	AN	2003/0098671	05/29/03	Hochgraf	322	36

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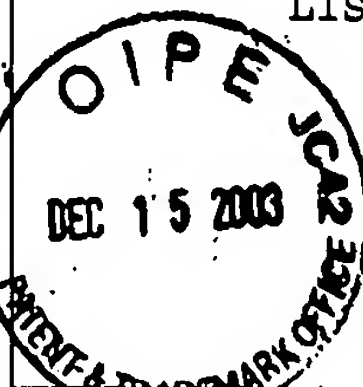
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	AP	EP 0 698 522	08/22/95	EPO		X
	AQ	DE 196 30 092	01/29/98	Germany		(Abstract Only)
	AR	JP 60-224959	11/09/85	Japan		(Abstract Only)
	AS	JP 08-210171	08/20/96	Japan		(Abstract Only)
✓	AT	1 534 288	11/29/78	United Kingdom		X
RTF	AU	DE 43 22 923 A1	01/12/95	Germany		(Abstract Only)

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AV Ron et al, "A Hydrogen Heat Pump Incorporated Into the Circuit of an Electric Power Plant," Proceedings of the Intersociety Energy Conversion Engineering Conference, Vol. 4, Conf. 24, pages 2097-2103 (1989).

EXAMINER: *Reddy*DATE CONSIDERED: *18 June 2004*

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 <p>LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT</p>		First Named Inventor:	
		Stephen T. Staphanos et al.	
		Filing Date	Group Art:
		July 22, 2003	

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Examiner Initial	Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
RTF	BA	4,419,667	12/06/83	Gurr et al.	340	825.06
	BB	6,095,793	08/01/00	Greeb	431	12
	BC	6,155,212	12/05/00	McAlister	123	3
	BD	6,351,692	02/26/02	Eaton et al.	700	287
	BE	6,384,903	05/07/02	Fuller	356	4.01
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RTF	BG	2002/0035497	03/21/02	Mazereeuw et al.	705	7
	BH					
	BI					
	BJ					
	BK					

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RTF	BL	GB 2,278,519				
	BM					
	BN					
	BO					
	BP					
	BQ					
	BS					

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